

**BATTERY PROTECTION IC FOR 2-SERIAL / 3-SERIAL CELL PACK  
(SECONDARY PROTECTION)**[www.ablicinc.com](http://www.ablicinc.com)

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Rev.1.4\_01

The S-8213 Series is used for secondary protection of lithium-ion rechargeable batteries, and incorporates a high-accuracy voltage detection circuit and a delay circuit. Short-circuits between VC3 to VSS accommodate serial connection of two cells or three cells.

**■ Features**

- High-accuracy voltage detection circuit for each cell
  - Overcharge detection voltage n (n = 1 to 3)
    - 4.100 V to 4.500 V (in 50 mV steps)
    - Accuracy:  $\pm 25$  mV ( $T_a = +25^\circ\text{C}$ )
    - Accuracy:  $\pm 30$  mV ( $T_a = 0^\circ\text{C}$  to  $+60^\circ\text{C}$ )
  - Overcharge hysteresis voltage n (n = 1 to 3)
    - $0\text{ V} \pm 25\text{ mV}$ ,  $-0.05\text{ V} \pm 25\text{ mV}$ ,  $-0.40\text{ V} \pm 80\text{ mV}$
- Delay times for overcharge detection can be set by an internal circuit only (external capacitors are unnecessary)
- Output form is selectable: CMOS output, Nch open-drain output
- Output logic is selectable: Active "H", Active "L"
- High-withstand voltage: Absolute maximum rating 26 V
- Wide operation voltage range: 3.6 V to 24 V
- Wide operation temperature range:  $T_a = -40^\circ\text{C}$  to  $+85^\circ\text{C}$
- Low current consumption
  - At  $V_{\text{CUn}} = 1.0\text{ V}$  for each cell: 2.0  $\mu\text{A}$  max. ( $T_a = +25^\circ\text{C}$ )
  - At 2.0 V for each cell: 0.3  $\mu\text{A}$  max. ( $T_a = +25^\circ\text{C}$ )
- Lead-free (Sn 100%), halogen-free

**■ Application**

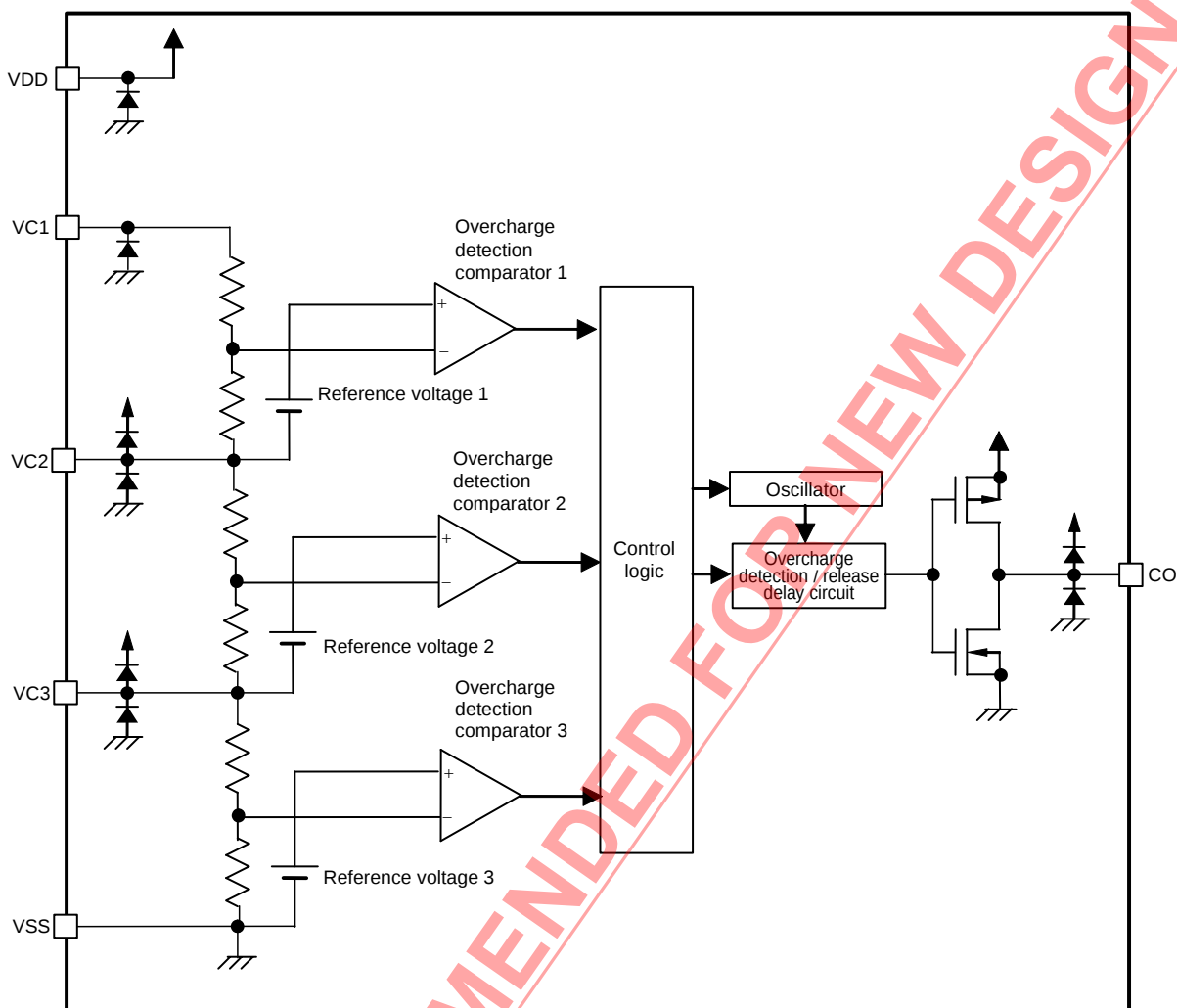
- Lithium-ion rechargeable battery pack (for secondary protection)

**■ Packages**

- SOT-23-6
- SNT-6A

## ■ Block Diagram

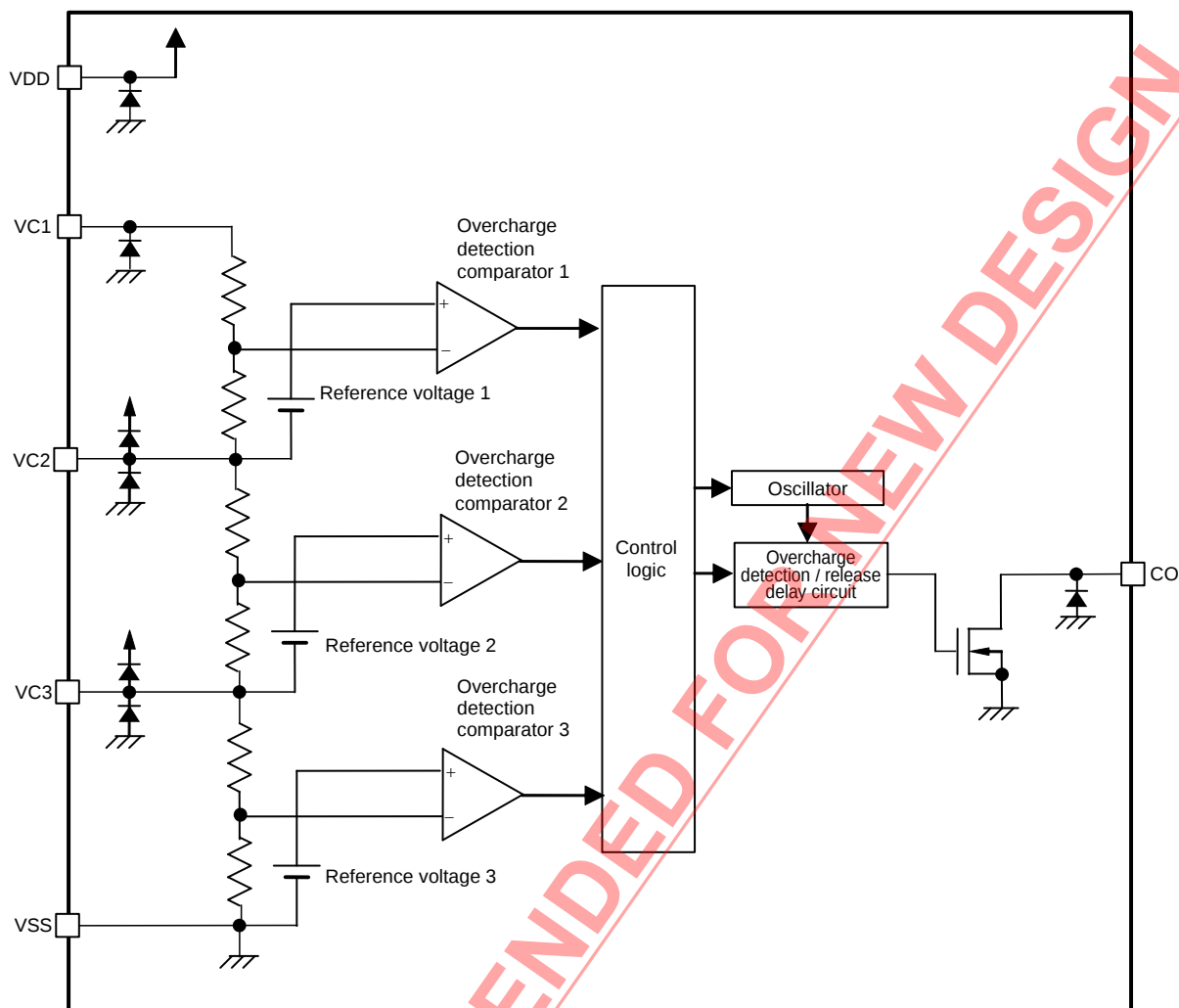
### 1. CMOS output product



**Remark** The diodes in the figure are parasitic diodes.

Figure 1

## 2. Nch open-drain output product

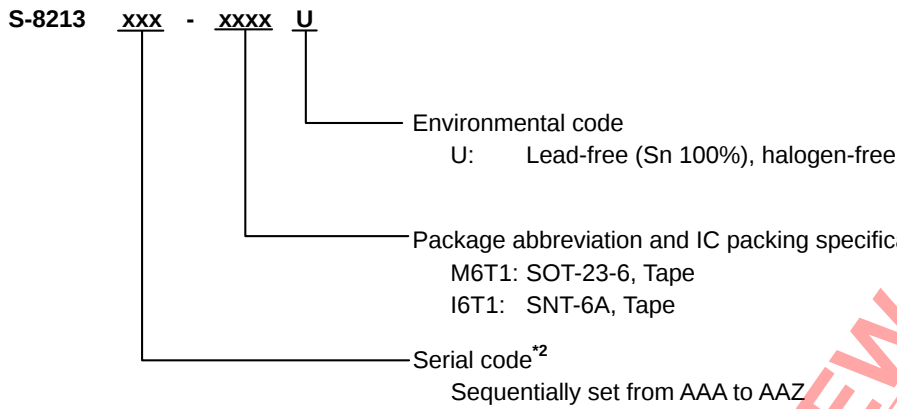


**Remark** The diodes in the figure are parasitic diodes.

Figure 2

## ■ Product Name Structure

### 1. Product name



\*1. Refer to the tape drawing.

\*2. Refer to "3. Product name list".

### 2. Packages

Table 1 Package Drawing Codes

| Package Name | Dimension    | Tape         | Reel         | Land         |
|--------------|--------------|--------------|--------------|--------------|
| SOT-23-6     | MP006-A-P-SD | MP006-A-C-SD | MP006-A-R-SD | —            |
| SNT-6A       | PG006-A-P-SD | PG006-A-C-SD | PG006-A-R-SD | PG006-A-L-SD |

### 3. Product name list

#### 3.1 SNT-6A

Table 2

| Product Name    | Overcharge Detection Voltage [V <sub>CU</sub> ] | Overcharge Hysteresis Voltage [V <sub>HC</sub> ] | Overcharge Detection Delay Time [t <sub>CU</sub> ] | Output Form           | Output Logic |
|-----------------|-------------------------------------------------|--------------------------------------------------|----------------------------------------------------|-----------------------|--------------|
| S-8213AAB-I6T1U | 4.300 V                                         | −0.40 V                                          | 2.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAC-I6T1U | 4.350 V                                         | −0.40 V                                          | 2.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAD-I6T1U | 4.400 V                                         | −0.40 V                                          | 2.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAE-I6T1U | 4.450 V                                         | −0.40 V                                          | 2.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAF-I6T1U | 4.500 V                                         | −0.40 V                                          | 2.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAG-I6T1U | 4.300 V                                         | −0.40 V                                          | 4.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAH-I6T1U | 4.350 V                                         | −0.40 V                                          | 4.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAI-I6T1U | 4.400 V                                         | −0.40 V                                          | 4.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAJ-I6T1U | 4.450 V                                         | −0.40 V                                          | 4.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAK-I6T1U | 4.500 V                                         | −0.40 V                                          | 4.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAL-I6T1U | 4.300 V                                         | −0.40 V                                          | 8.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAM-I6T1U | 4.350 V                                         | −0.40 V                                          | 8.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAN-I6T1U | 4.400 V                                         | −0.40 V                                          | 8.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAO-I6T1U | 4.450 V                                         | −0.40 V                                          | 8.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAP-I6T1U | 4.500 V                                         | −0.40 V                                          | 8.0 s                                              | CMOS output           | Active "H"   |
| S-8213AAQ-I6T1U | 4.150 V                                         | −0.05 V                                          | 2.0 s                                              | CMOS output           | Active "L"   |
| S-8213AAR-I6T1U | 4.250 V                                         | −0.05 V                                          | 2.0 s                                              | CMOS output           | Active "L"   |
| S-8213AAS-I6T1U | 4.150 V                                         | −0.05 V                                          | 2.0 s                                              | Nch open-drain output | Active "H"   |
| S-8213AAT-I6T1U | 4.250 V                                         | −0.05 V                                          | 2.0 s                                              | Nch open-drain output | Active "H"   |

**Remark** Please contact our sales department for the products with detection voltage value other than those specified above.

## ■ Pin Configurations

### 1. SOT-23-6

Top view

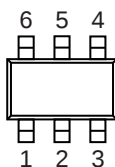


Figure 3

Table 3

| Pin No. | Symbol | Description                                                                                           |
|---------|--------|-------------------------------------------------------------------------------------------------------|
| 1       | VSS    | Input pin for negative power supply,<br>connection pin for negative voltage of battery 3              |
| 2       | VC3    | Connection pin for negative voltage of battery 2,<br>connection pin for positive voltage of battery 3 |
| 3       | VC2    | Connection pin for negative voltage of battery 1,<br>connection pin for positive voltage of battery 2 |
| 4       | VC1    | Connection pin for positive voltage of battery 1                                                      |
| 5       | VDD    | Input pin for positive power supply                                                                   |
| 6       | CO     | Connection pin of charge control FET gate                                                             |

### 2. SNT-6A

Top view

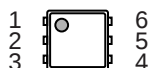


Figure 4

Table 4

| Pin No. | Symbol | Description                                                                                           |
|---------|--------|-------------------------------------------------------------------------------------------------------|
| 1       | CO     | Connection pin of charge control FET gate                                                             |
| 2       | VDD    | Input pin for positive power supply                                                                   |
| 3       | VC1    | Connection pin for positive voltage of battery 1                                                      |
| 4       | VC2    | Connection pin for negative voltage of battery 1,<br>connection pin for positive voltage of battery 2 |
| 5       | VC3    | Connection pin for negative voltage of battery 2,<br>connection pin for positive voltage of battery 3 |
| 6       | VSS    | Input pin for negative power supply,<br>connection pin for negative voltage of battery 3              |

## ■ Absolute Maximum Ratings

Table 5

(Ta = +25°C unless otherwise specified)

| Item                              | Symbol                        | Applied Pin    | Absolute Maximum Rating                        | Unit |
|-----------------------------------|-------------------------------|----------------|------------------------------------------------|------|
| Input voltage between VDD and VSS | V <sub>DS</sub>               | VDD            | V <sub>SS</sub> - 0.3 to V <sub>SS</sub> + 26  | V    |
| Input pin voltage                 | V <sub>IN</sub>               | VC1, VC2, VC3  | V <sub>SS</sub> - 0.3 to V <sub>DD</sub> + 0.3 | V    |
| CO output pin voltage             | CMOS output product           | CO             | V <sub>SS</sub> - 0.3 to V <sub>DD</sub> + 0.3 | V    |
|                                   | Nch open-drain output product |                | V <sub>SS</sub> - 0.3 to V <sub>SS</sub> + 26  | V    |
| Power dissipation                 | SOT-23-6                      | P <sub>D</sub> | 650 <sup>*1</sup>                              | mW   |
|                                   | SNT-6A                        |                | 400 <sup>*1</sup>                              | mW   |
| Operation ambient temperature     | T <sub>opr</sub>              | —              | -40 to +85                                     | °C   |
| Storage temperature               | T <sub>stg</sub>              | —              | -40 to +125                                    | °C   |

\*1. When mounted on board

[Mounted board]

(1) Board size: 114.3 mm × 76.2 mm × t1.6 mm

(2) Name: JEDEC STANDARD51-7

**Caution** The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

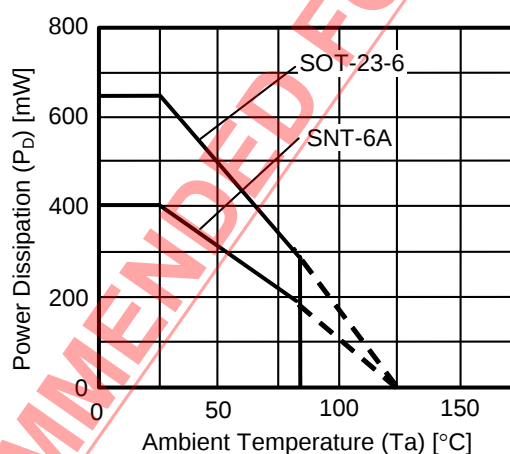


Figure 5 Power Dissipation of Package (When Mounted on Board)

## ■ Electrical Characteristics

Table 6

(Ta = +25°C unless otherwise specified)

| Item                                                   | Symbol                              | Condition                              | Min.                    | Typ.            | Max.                    | Unit | Test Circuit |
|--------------------------------------------------------|-------------------------------------|----------------------------------------|-------------------------|-----------------|-------------------------|------|--------------|
| DETECTION VOLTAGE                                      |                                     |                                        |                         |                 |                         |      |              |
| Overcharge detection voltage n (n = 1, 2, 3)           | V <sub>CU<sub>n</sub></sub>         | —                                      | V <sub>CU</sub> − 0.025 | V <sub>CU</sub> | V <sub>CU</sub> + 0.025 | V    | 1            |
|                                                        |                                     | Ta = 0°C to +60°C*1                    | V <sub>CU</sub> − 0.030 | V <sub>CU</sub> | V <sub>CU</sub> + 0.030 | V    | 1            |
| Overcharge hysteresis voltage n (n = 1, 2, 3)          | V <sub>HC<sub>n</sub></sub>         | V <sub>HC</sub> = −0.40 V              | V <sub>HC</sub> − 0.080 | V <sub>HC</sub> | V <sub>HC</sub> + 0.080 | V    | 1            |
|                                                        |                                     | V <sub>HC</sub> = 0 V, −0.05 V         | V <sub>HC</sub> − 0.025 | V <sub>HC</sub> | V <sub>HC</sub> + 0.025 | V    | 1            |
| INPUT VOLTAGE                                          |                                     |                                        |                         |                 |                         |      |              |
| Operation voltage between VDD and VSS                  | V <sub>DSOP</sub>                   | —                                      | 3.6                     | —               | 24                      | V    | —            |
| INPUT CURRENT                                          |                                     |                                        |                         |                 |                         |      |              |
| Current consumption during operation                   | I <sub>OPE</sub>                    | V1 = V2 = V3 = V <sub>CU</sub> − 1.0 V | —                       | —               | 2.0                     | μA   | 3            |
| Current consumption during overdischarge               | I <sub>PDN</sub>                    | V1 = V2 = V3 = 2.0 V                   | —                       | —               | 0.3                     | μA   | 3            |
| VC1 pin current                                        | I <sub>VC1</sub>                    | V1 = V2 = V3 = V <sub>CU</sub> − 1.0 V | —                       | —               | 0.3                     | μA   | 4            |
| VC2 pin, VC3 pin current                               | I <sub>VC2</sub> , I <sub>VC3</sub> | V1 = V2 = V3 = V <sub>CU</sub> − 1.0 V | −0.3                    | 0               | 0.3                     | μA   | 4            |
| OUTPUT CURRENT                                         |                                     |                                        |                         |                 |                         |      |              |
| CO pin sink current                                    | I <sub>COL</sub>                    | —                                      | 0.4                     | —               | —                       | mA   | 5            |
| CO pin source current (CMOS output product)            | I <sub>COH</sub>                    | —                                      | 20                      | —               | —                       | μA   | 5            |
| CO pin leakage current (Nch open-drain output product) | I <sub>COLL</sub>                   | —                                      | —                       | —               | 0.1                     | μA   | 5            |
| DELAY TIME                                             |                                     |                                        |                         |                 |                         |      |              |
| Overcharge detection delay time                        | t <sub>CU</sub>                     | —                                      | t <sub>CU</sub> × 0.8   | t <sub>CU</sub> | t <sub>CU</sub> × 1.2   | s    | 1            |
| Transition time to test mode                           | t <sub>TST</sub>                    | —                                      | —                       | —               | 20                      | ms   | 2            |

\*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

## ■ Test Circuits

### 1. Overcharge detection voltage, overcharge hysteresis voltage (Test circuit 1)

Set SW1 to OFF and ON in CMOS output product and Nch open-drain output product, respectively.

#### 1. 1 Overcharge detection voltage $n$ ( $V_{CU_n}$ )

Set  $V1 = V2 = V3 = V_{CU} - 0.05$  V. The Overcharge detection voltage 1 ( $V_{CU1}$ ) is the V1 voltage when the CO pin's output changes after the voltage of V1 has been gradually increased.

Overcharge detection voltage  $V_{CU_n}$  ( $n = 2, 3$ ) can be determined in the same way as when  $n = 1$ .

#### 1. 2 Overcharge hysteresis voltage $n$ ( $V_{HC_n}$ )

Set  $V1 = V_{CU} + 0.05$  V,  $V2 = V3 = 2.5$  V. The overcharge hysteresis voltage 1 ( $V_{HC1}$ ) is the difference between V1 voltage and  $V_{CU1}$  when the CO pin's output changes after the V1 voltage has been gradually decreased.

Overcharge hysteresis voltage  $V_{HC_n}$  ( $n = 2, 3$ ) can be determined in the same way as when  $n = 1$ .

### 2. Output current (Test circuit 5)

Set SW1 and SW2 to OFF.

#### 2. 1 Active "H"

##### 2. 1. 1 CO pin source current ( $I_{COH}$ )

Set SW1 to ON after setting  $V1 = 5.0$  V,  $V2 = V3 = 3.0$  V,  $V4 = 0.5$  V. I1 is the CO pin source current ( $I_{COH}$ ) at that time.

##### 2. 1. 2 CO pin sink current ( $I_{COL}$ )

Set SW2 to ON after setting  $V1$  to  $V3 = 3.5$  V,  $V5 = 0.5$  V. I2 is the CO pin sink current ( $I_{COL}$ ) at that time.

##### 2. 1. 3 CO pin leakage current ( $I_{COLL}$ )

Set SW2 to ON after setting  $V1 = 5.0$  V,  $V2 = V3 = 3.0$  V,  $V5 = 26$  V. I2 is the CO pin leakage current ( $I_{COLL}$ ) at that time.

#### 2. 2 Active "L"

##### 2. 2. 1 CO pin source current ( $I_{COH}$ )

Set SW1 to ON after setting  $V1$  to  $V3 = 3.5$  V,  $V4 = 0.5$  V. I1 is the CO pin source current ( $I_{COH}$ ) at that time.

##### 2. 2. 2 CO pin sink current ( $I_{COL}$ )

Set SW2 to ON after setting  $V1 = 5.0$  V,  $V2 = V3 = 3.0$  V,  $V5 = 0.5$  V. I2 is the CO pin sink current ( $I_{COL}$ ) at that time.

##### 2. 2. 3 CO pin leakage current ( $I_{COLL}$ )

Set SW2 to ON after setting  $V1$  to  $V3 = 3.5$  V,  $V5 = 26$  V. I2 is the CO pin leakage current ( $I_{COLL}$ ) at that time.

### 3. Overcharge detection delay time ( $t_{CU}$ ) (Test circuit 1)

Set SW1 to OFF and ON in CMOS output product and Nch open-drain output product, respectively.

Increase V1 up to 5.0 V after setting V1 = V2 = V3 = 3.5 V. The overcharge detection delay time ( $t_{CU}$ ) is the time period until the CO pin output changes.

### 4. Transition time to test mode ( $t_{TST}$ ) (Test circuit 2)

Set SW1 to OFF and ON in CMOS output product and Nch open-drain output product, respectively.

Increase V4 up to 4.0 V, and decrease V4 again to 0 V after setting V1 = V2 = V3 = 3.5 V, and V4 = 0 V.

When the period from when V4 was raised to when it has fallen is short, if an overcharge detection operation is performed subsequently, the delay time is  $t_{CU}$ . However, when the period from when V4 is raised to when it has fallen is gradually made longer, the delay time during the subsequent overcharge detection operation is shorter than  $t_{CU}$ . The transition time to test mode ( $t_{TST}$ ) is the period from when V4 was raised to when it has fallen at that time.

NOT RECOMMENDED FOR NEW DESIGN

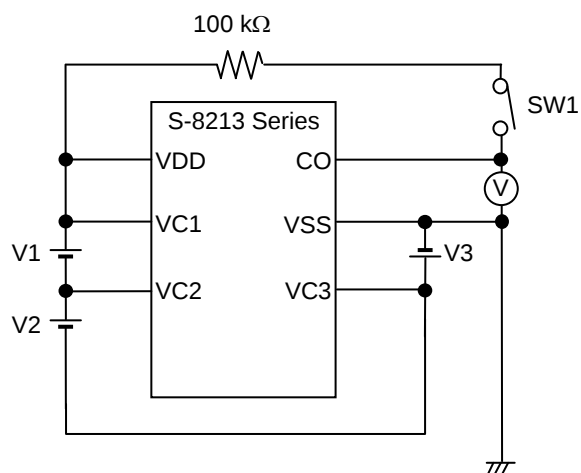


Figure 6 Test Circuit 1

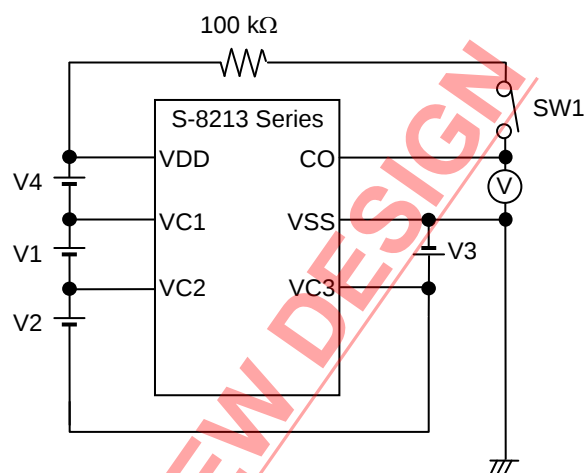


Figure 7 Test Circuit 2

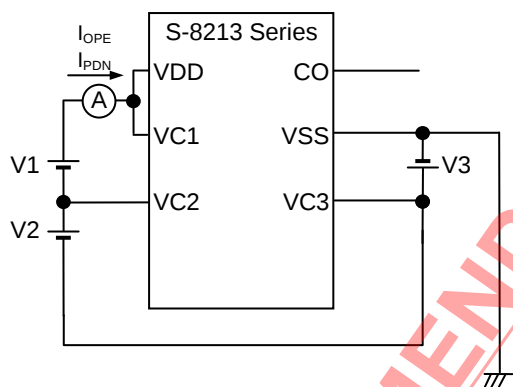


Figure 8 Test Circuit 3

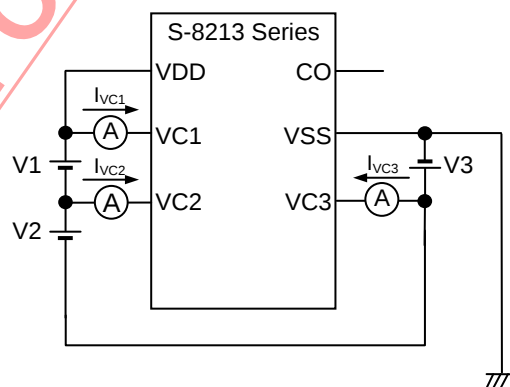


Figure 9 Test Circuit 4

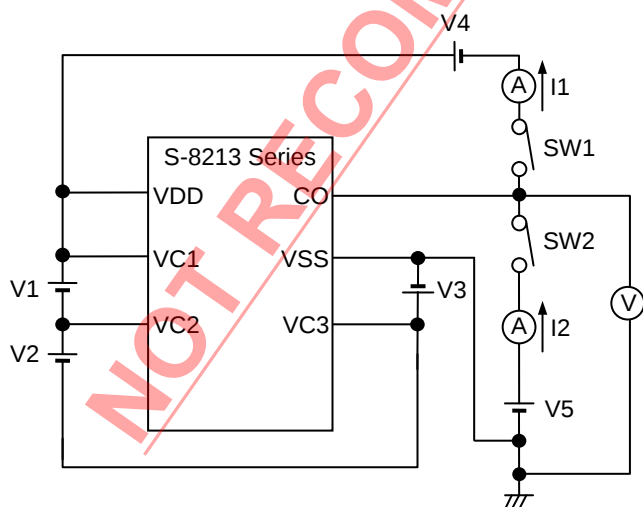


Figure 10 Test Circuit 5

## ■ Operation

**Remark** Refer to "■ Battery Protection IC Connection Examples".

### 1. Normal status

If the voltage of each of the batteries is lower than "the overcharge detection voltage ( $V_{CUH}$ ) + the overcharge hysteresis voltage ( $V_{HCN}$ )", CO pin output changes to "L" (Active "H") or "H" (Active "L"). This is called normal status.

### 2. Overcharge status

When the voltage of one of the batteries exceeds  $V_{CUH}$  during charging under normal conditions and the status is retained for the overcharge detection delay time ( $t_{CU}$ ) or longer, CO pin output changes. This is called overcharge status. Connecting FET to the CO pin provides charge control and a second protection.

If the voltage of each of the batteries is lower than  $V_{CUH} + V_{HCN}$  and the status is retained for 2.0 ms typ. or longer, the S-8213 Series changes to normal status.

NOT RECOMMENDED FOR NEW DESIGN

### 3. Test mode

The overcharge detection delay time ( $t_{CU}$ ) can be shortened by entering the test mode.

The test mode can be set by retaining the VDD pin voltage 4.0 V or more higher than the VC1 pin voltage for 20 ms or longer. The status is retained by the internal latch and the test mode is retained even if the VDD pin voltage is decreased to the same voltage as that of the VC1 pin voltage.

After that, the latch for retaining the test mode is reset and the S-8213 Series exits from test mode under the overcharge status.

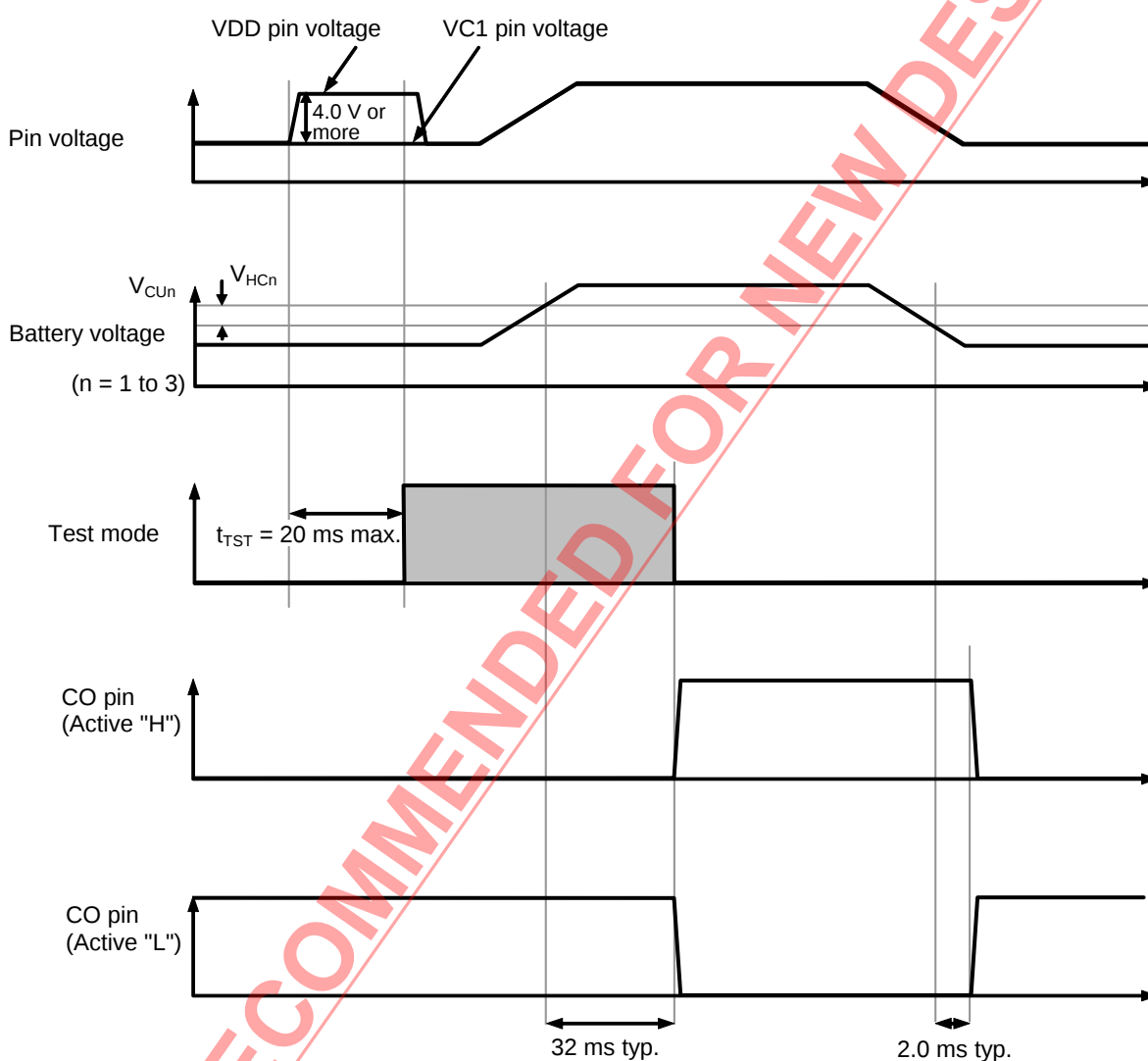


Figure 11

## ■ Timing Charts

### 1. Overcharge detection operation

#### 1.1 CMOS output product

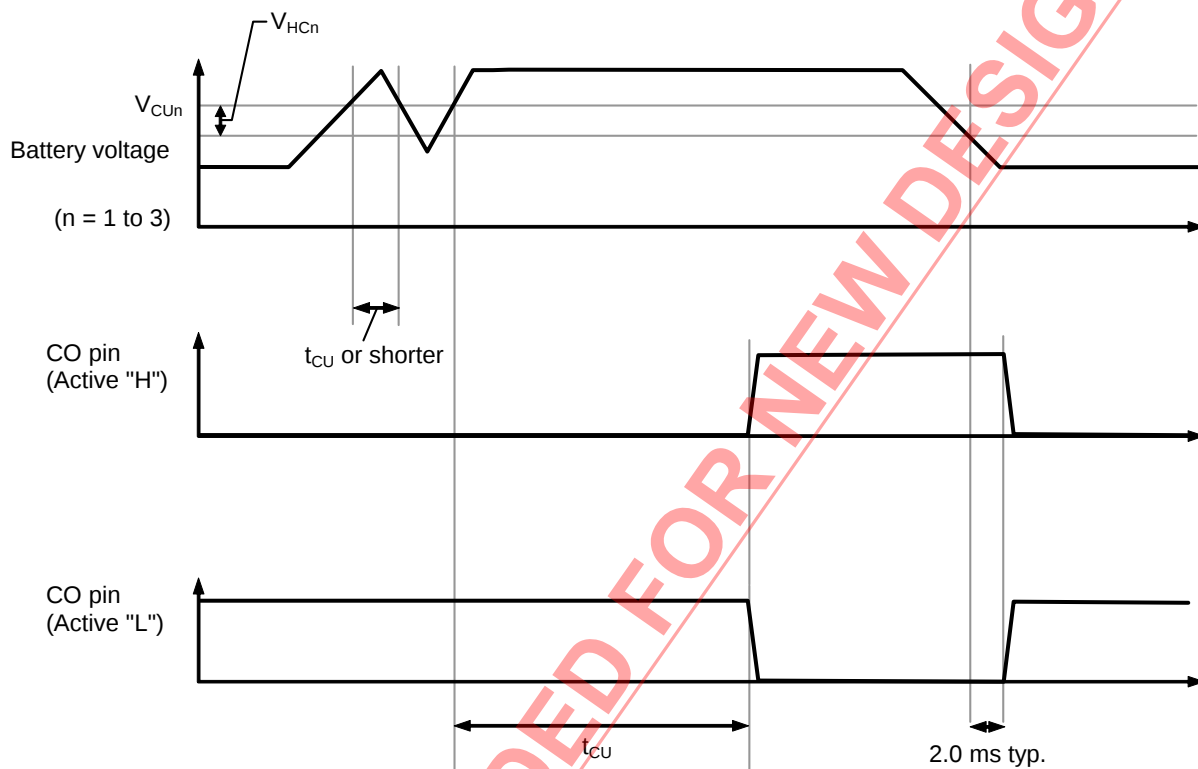


Figure 12

1. 2 Nch open-drain output product

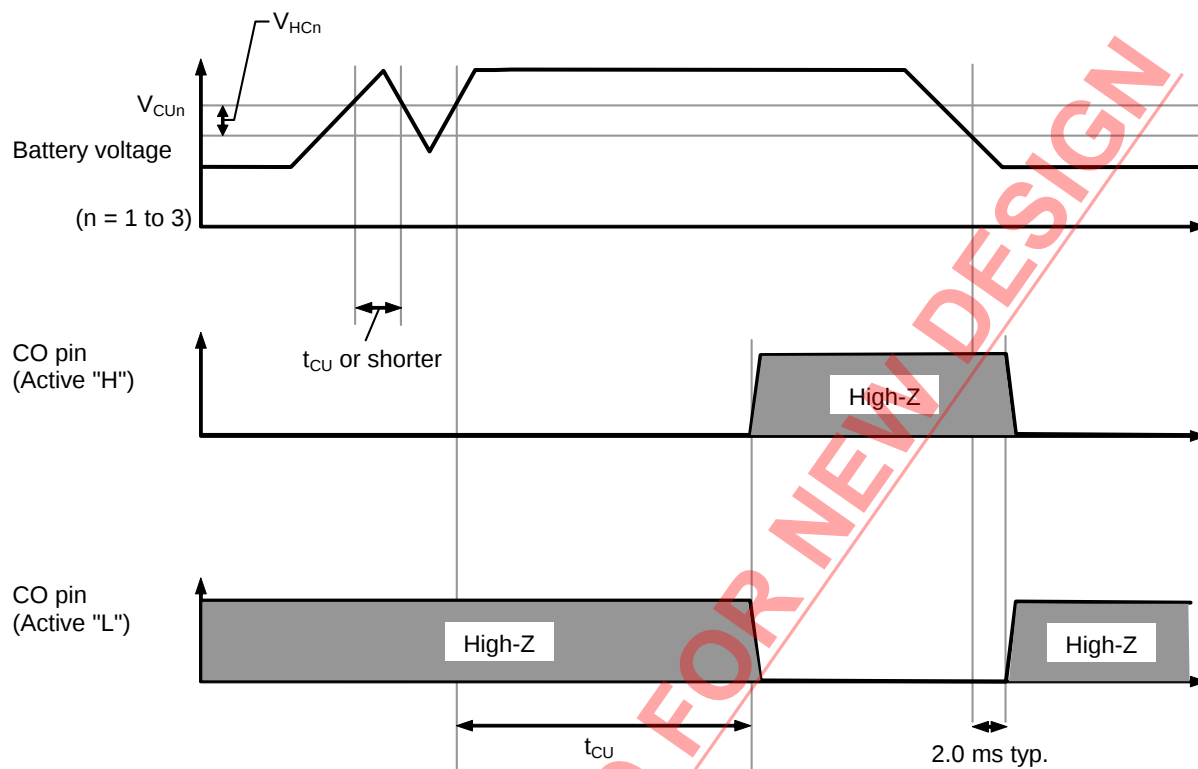


Figure 13

## ■ Battery Protection IC Connection Examples

### 1. 3-serial cell (CMOS output product)

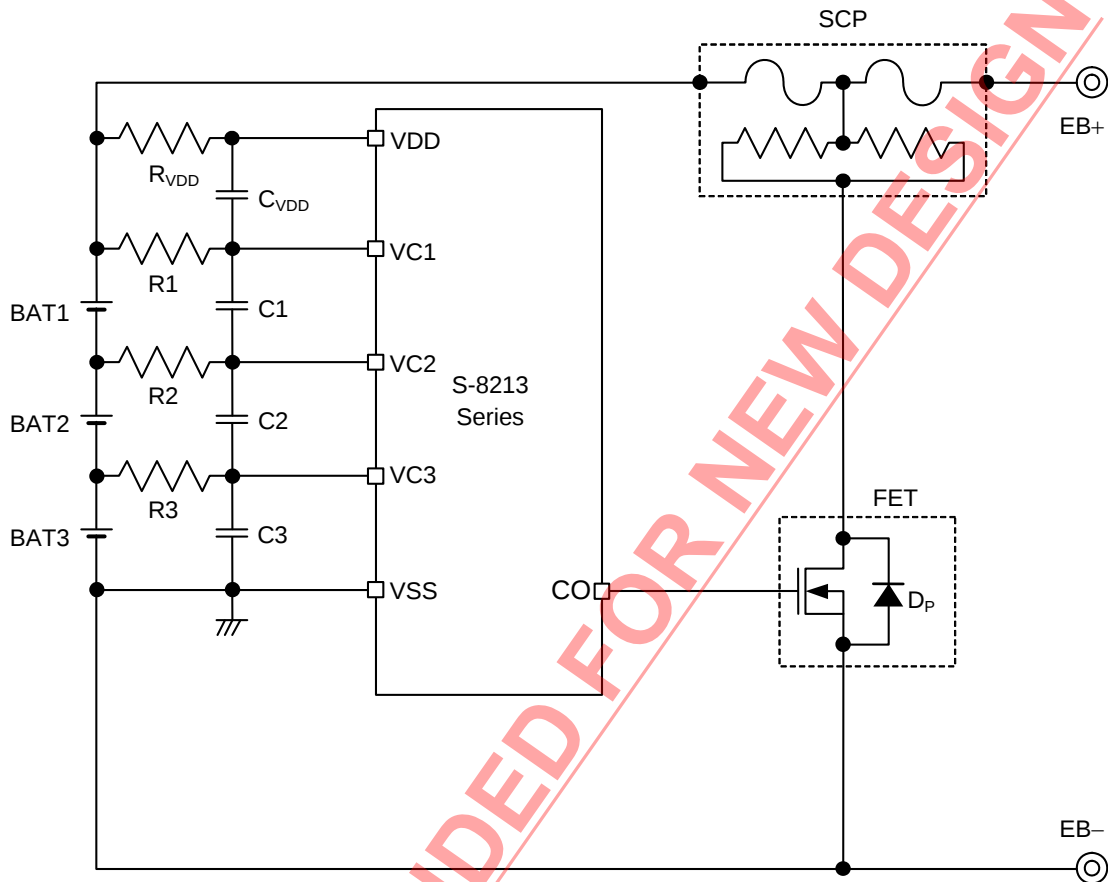


Figure 14

Table 7 Constants for External Components

| No. | Part                       | Min. | Typ. | Max. | Unit       |
|-----|----------------------------|------|------|------|------------|
| 1   | R1 to R3                   | 0.2  | 1    | 2    | k $\Omega$ |
| 2   | C1 to C3, C <sub>VDD</sub> | 0.01 | 0.1  | 1    | $\mu$ F    |
| 3   | R <sub>VDD</sub>           | 50   | 100  | 500  | $\Omega$   |

- Caution**
1. The above constants are subject to change without prior notice.
  2. It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.
  3. Set the same constants to R1 to R3 and to C1 to C3 and C<sub>VDD</sub>.
  4. Set R<sub>VDD</sub>, C1 to C3, and C<sub>VDD</sub> so that the condition  $(R_{VDD}) \times (C1 \text{ to } C3, C_{VDD}) \geq 5 \times 10^{-6}$  is satisfied.
  5. Set R1 to R3, C1 to C3, and C<sub>VDD</sub> so that the condition  $(R1 \text{ to } R3) \times (C1 \text{ to } C3, C_{VDD}) \geq 1 \times 10^{-4}$  is satisfied.
  6. Since CO pin may become detection status transiently when the battery is being connected, connect the positive terminal of BAT1 last in order to prevent the three terminal protection fuse from cutoff.

## 2. 2-serial cell (CMOS output product)

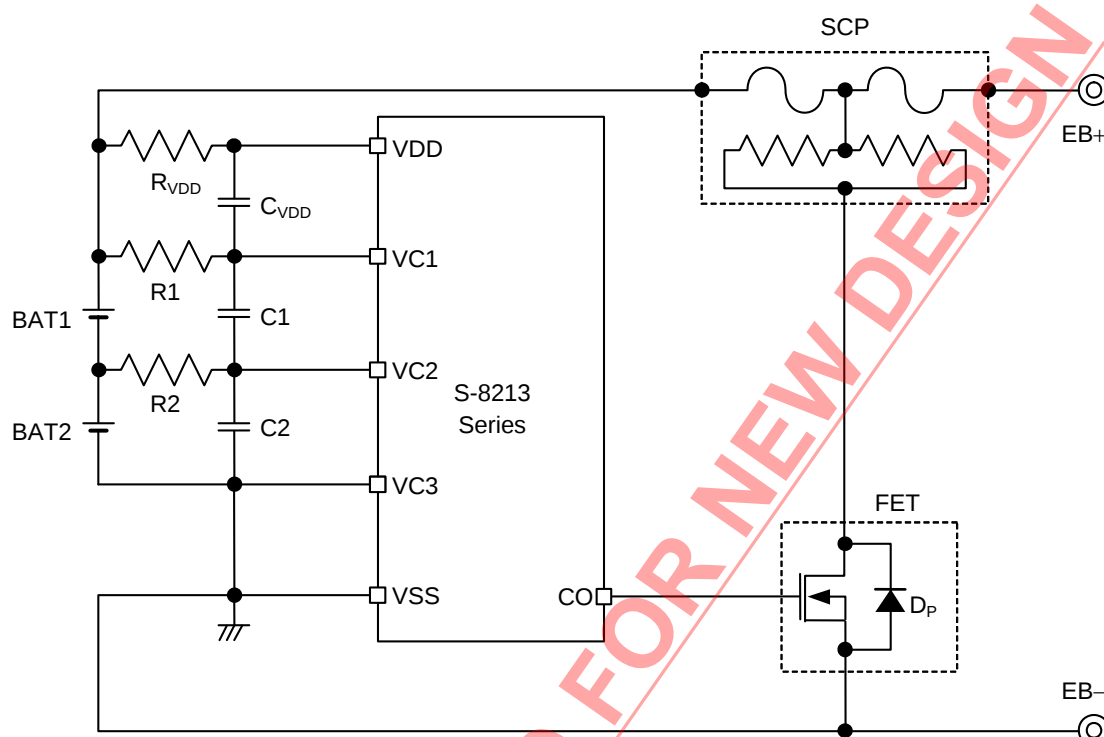


Figure 15

Table 8 Constants for External Components

| No. | Part         | Min. | Typ. | Max. | Unit |
|-----|--------------|------|------|------|------|
| 1   | R1, R2       | 0.2  | 1    | 2    | kΩ   |
| 2   | C1, C2, CVDD | 0.01 | 0.1  | 1    | μF   |
| 3   | RVDD         | 50   | 100  | 500  | Ω    |

- Caution**
1. The above constants are subject to change without prior notice.
  2. It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.
  3. Set the same constants to R1, R2 and to C1, C2 and CVDD.
  4. Set RVDD, C1, C2, and CVDD so that the condition  $(RVDD) \times (C1, C2, CVDD) \geq 5 \times 10^{-6}$  is satisfied.
  5. Set R1, R2, C1, C2, and CVDD so that the condition  $(R1, R2) \times (C1, C2, CVDD) \geq 1 \times 10^{-4}$  is satisfied.
  6. Since CO pin may become detection status transiently when the battery is being connected, connect the positive terminal of BAT1 last in order to prevent the three terminal protection fuse from cutoff.

**[For SCP, contact]**

Global Sales & Marketing Division, Dexerials Corporation  
Gate City Osaki East Tower 8F, 1-11-2  
Osaki, Shinagawa-ku, Tokyo, 141-0032, Japan  
TEL +81-3-5435-3946  
Contact Us: <http://www.dexerials.jp/en/>

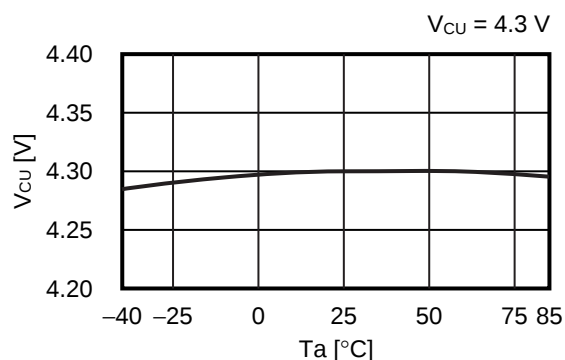
**■ Precautions**

- Do not connect batteries charged with  $V_{CUH} + V_{HCN}$  or higher. If the connected batteries include a battery charged with  $V_{CUH} + V_{HCN}$  or more, the S-8213 series may become overcharge status after all pins are connected.
- In some application circuits, even if an overcharged battery is not included, the order of connecting batteries may be restricted to prevent transient output of CO detection pulses when the batteries are connected. Perform thorough evaluation with the actual application circuit.
- Before the battery connection, short-circuit the battery side pins  $R_{VDD}$  and  $R1$ , shown in the figure in "■ Battery Protection IC Connection Examples".
- The application conditions for the input voltage, output voltage, and load current should not exceed the package power dissipation.
- Do not apply to this IC an electrostatic discharge that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement of patents owned by a third party by products including this IC.

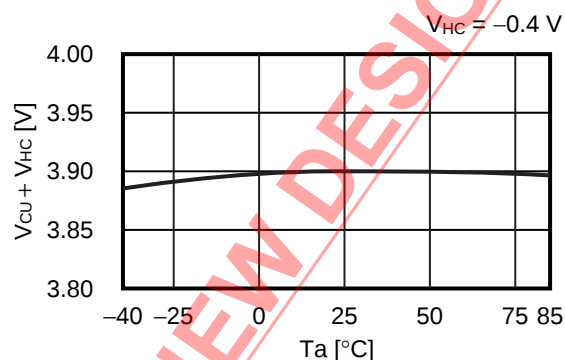
## ■ Characteristics (Typical Data)

### 1. Detection voltage

#### 1. 1 $V_{CU}$ vs. $T_a$

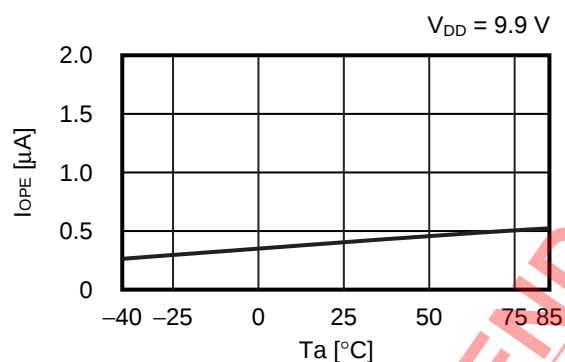


#### 1. 2 $V_{CU} + V_{HC}$ vs. $T_a$

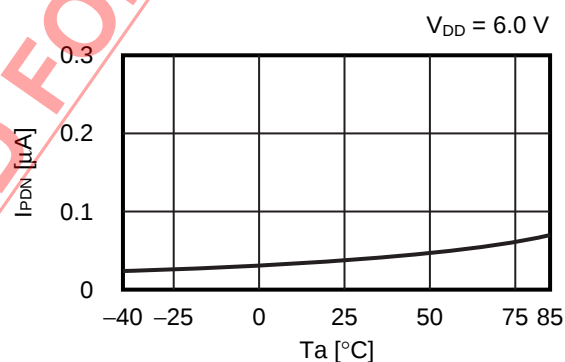


### 2. Current consumption

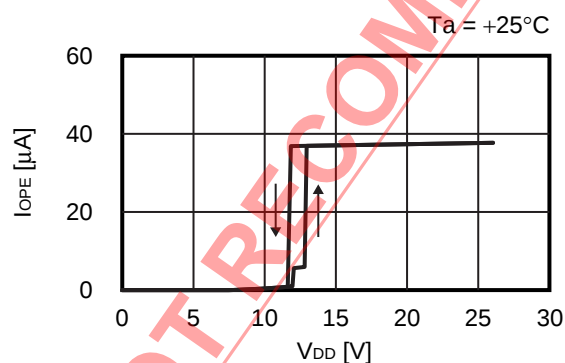
#### 2. 1 $I_{OPE}$ vs. $T_a$



#### 2. 2 $I_{PDN}$ vs. $T_a$

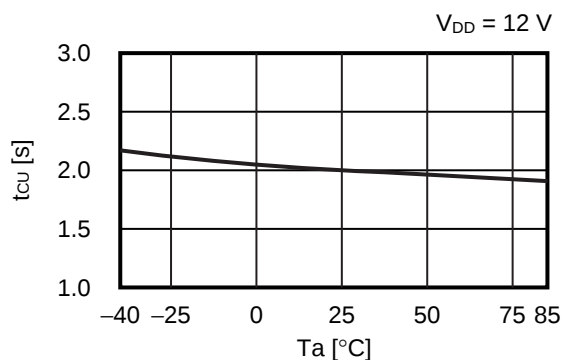


#### 2. 3 $I_{OPE}$ vs. $V_{DD}$



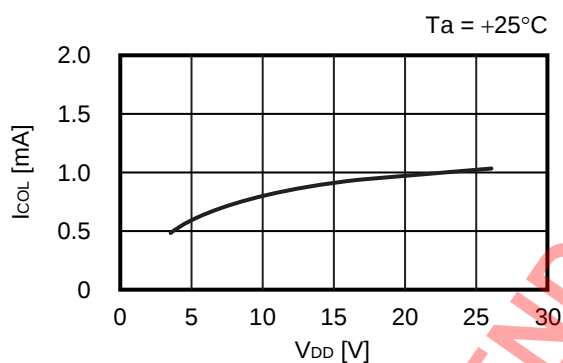
### 3. Delay time

#### 3. 1 $t_{CU}$ vs. $T_a$

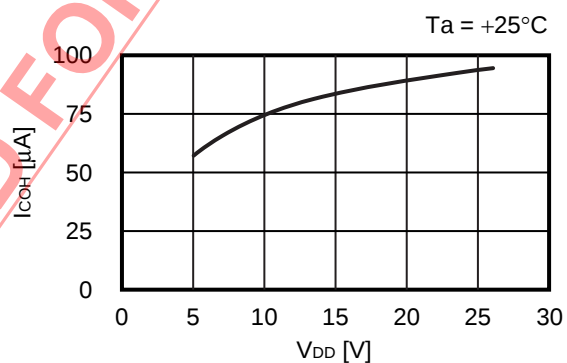


### 4. Output current

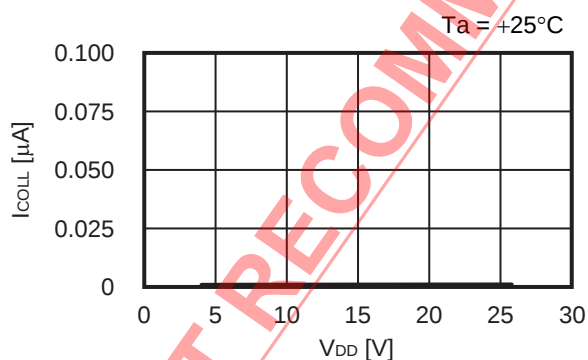
#### 4. 1 $I_{COL}$ vs. $V_{DD}$



#### 4. 2 $I_{COH}$ vs. $V_{DD}$

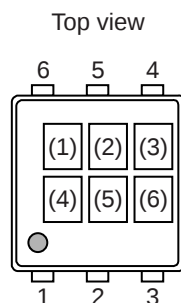


#### 4. 3 $I_{COLL}$ vs. $V_{DD}$



## ■ Marking Specification

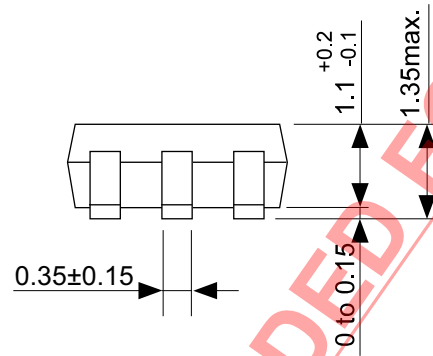
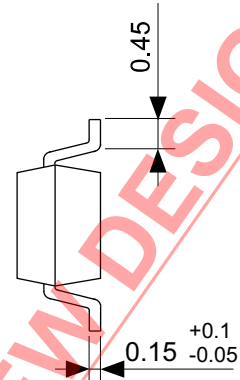
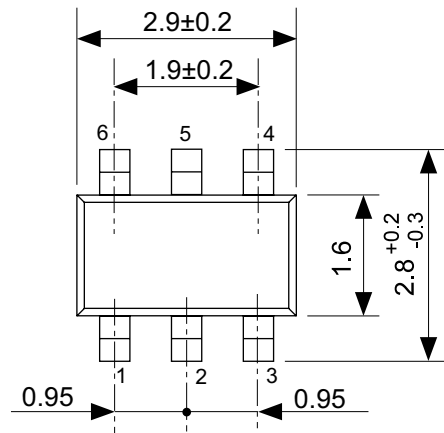
### 1. SNT-6A



(1) to (3): Product code (Refer to **Product name vs. Product code**)  
 (4) to (6): Lot number

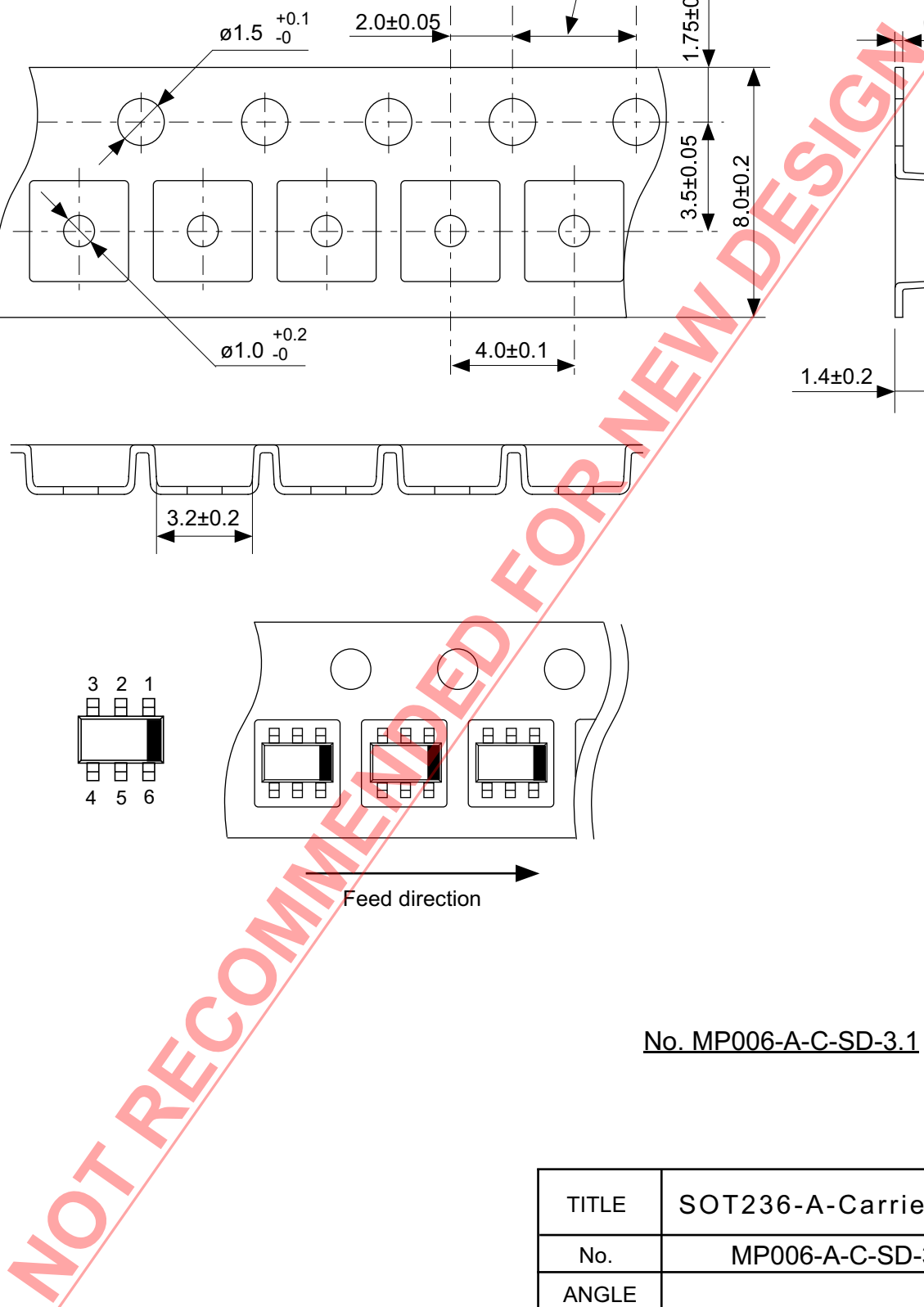
#### Product name vs. Product code

| Product Name    | Product Code |     |     |
|-----------------|--------------|-----|-----|
|                 | (1)          | (2) | (3) |
| S-8213AAB-I6T1U | S            | U   | B   |
| S-8213AAC-I6T1U | S            | U   | C   |
| S-8213AAD-I6T1U | S            | U   | D   |
| S-8213AAE-I6T1U | S            | U   | E   |
| S-8213AAF-I6T1U | S            | U   | F   |
| S-8213AAG-I6T1U | S            | U   | G   |
| S-8213AAH-I6T1U | S            | U   | H   |
| S-8213AAI-I6T1U | S            | U   | I   |
| S-8213AAJ-I6T1U | S            | U   | J   |
| S-8213AAK-I6T1U | S            | U   | K   |
| S-8213AAL-I6T1U | S            | U   | L   |
| S-8213AAM-I6T1U | S            | U   | M   |
| S-8213AAN-I6T1U | S            | U   | N   |
| S-8213AAO-I6T1U | S            | U   | O   |
| S-8213AAP-I6T1U | S            | U   | P   |
| S-8213AAQ-I6T1U | S            | U   | Q   |
| S-8213AAR-I6T1U | S            | U   | R   |
| S-8213AAS-I6T1U | S            | U   | S   |
| S-8213AAT-I6T1U | S            | U   | T   |



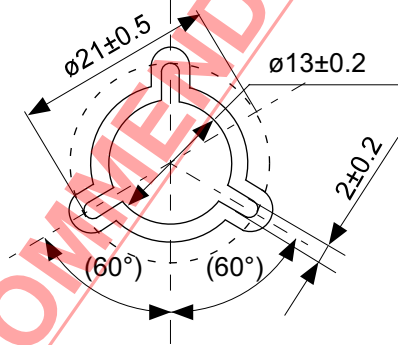
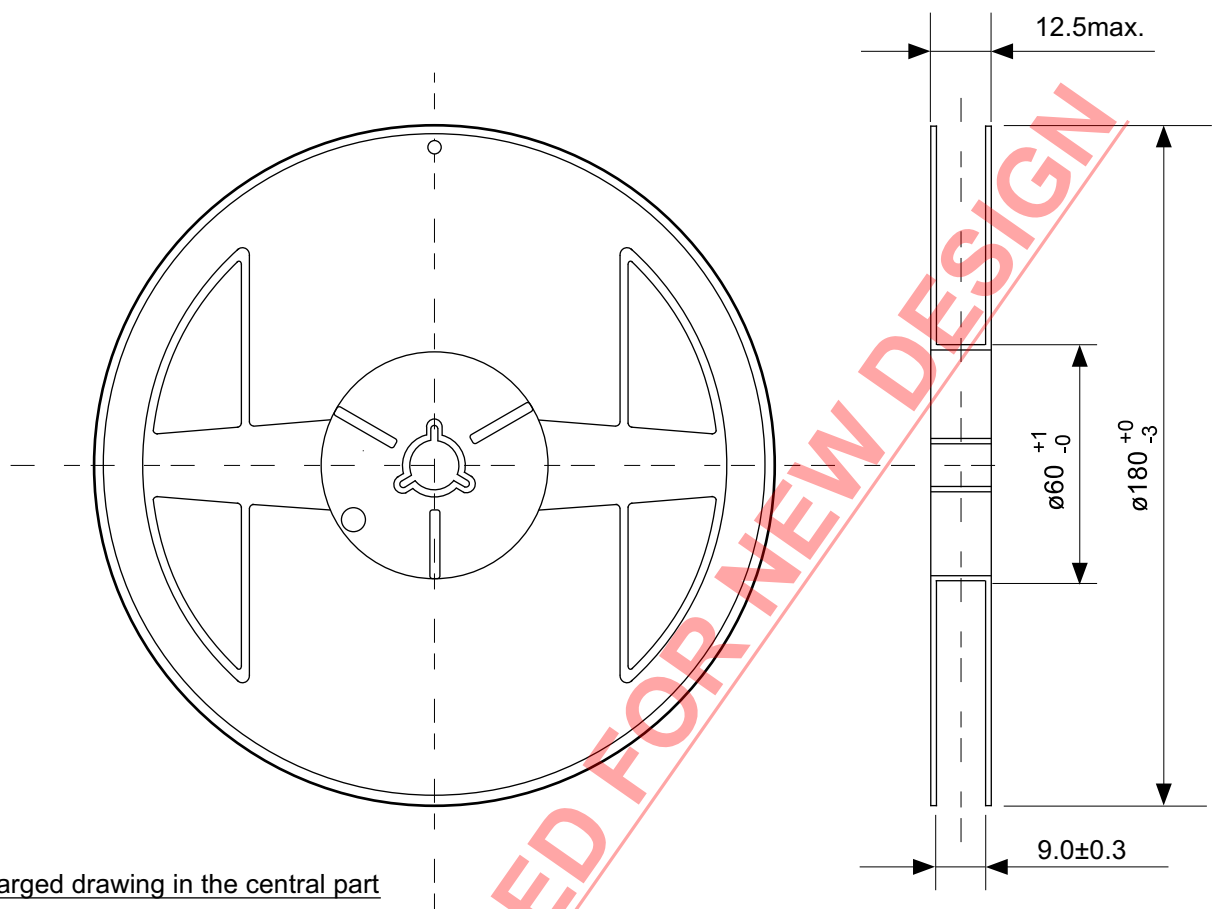
No. MP006-A-P-SD-2.1

|            |                                                                                       |
|------------|---------------------------------------------------------------------------------------|
| TITLE      | SOT236-A-PKG Dimensions                                                               |
| No.        | MP006-A-P-SD-2.1                                                                      |
| ANGLE      |  |
| UNIT       | mm                                                                                    |
| ABLIC Inc. |                                                                                       |



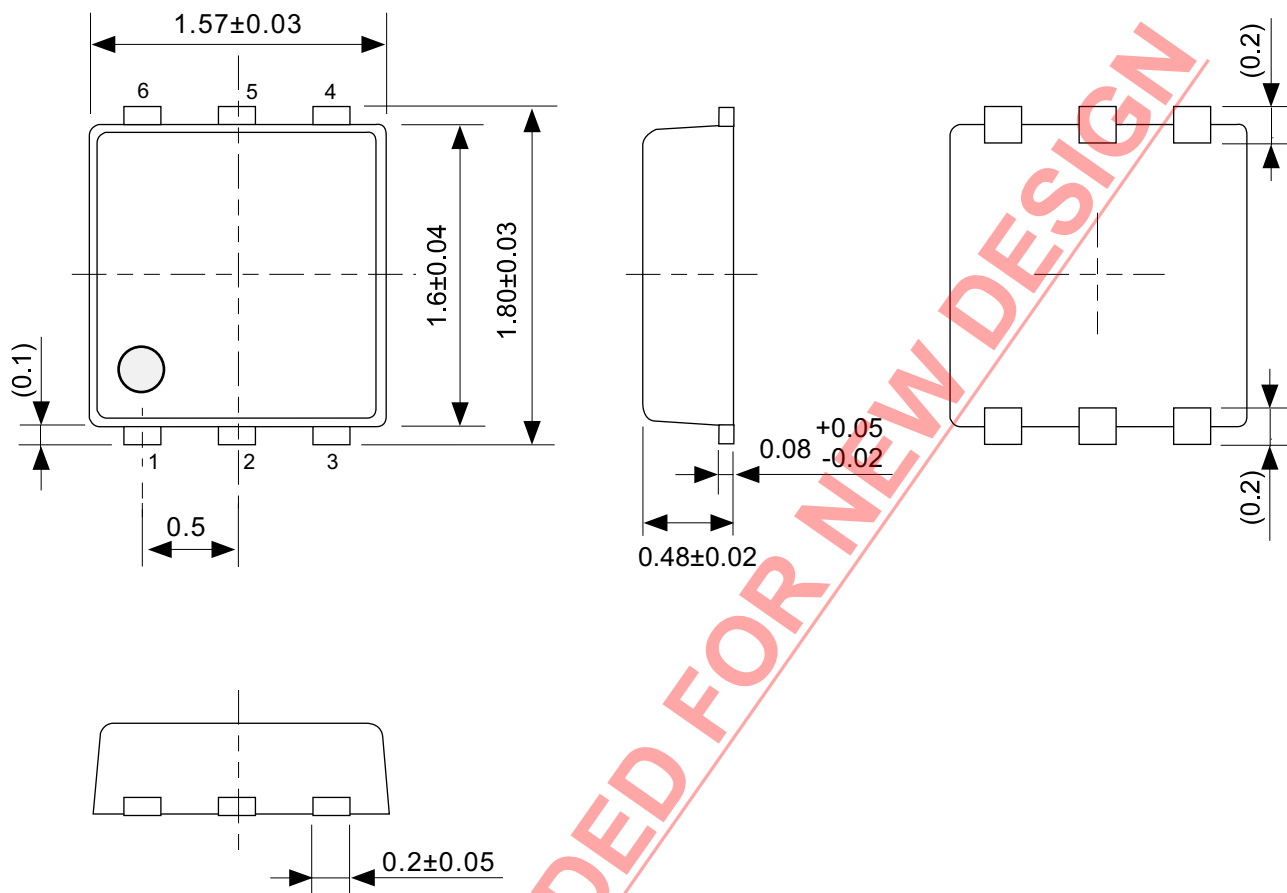
No. MP006-A-C-SD-3.1

|                   |                       |
|-------------------|-----------------------|
| TITLE             | SOT236-A-Carrier Tape |
| No.               | MP006-A-C-SD-3.1      |
| ANGLE             |                       |
| UNIT              | mm                    |
|                   |                       |
| <b>ABLIC Inc.</b> |                       |



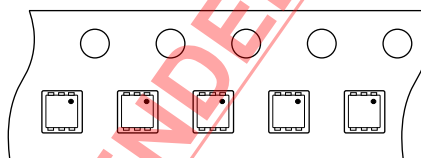
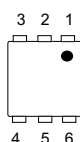
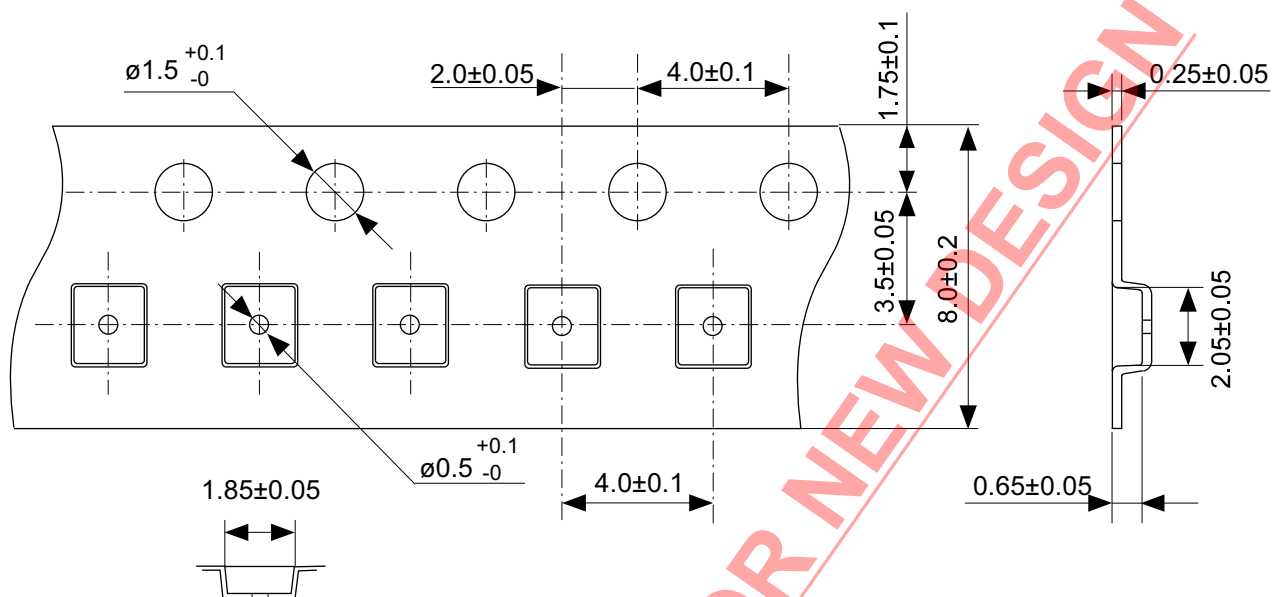
No. MP006-A-R-SD-2.1

|            |                  |     |       |
|------------|------------------|-----|-------|
| TITLE      | SOT236-A-Reel    |     |       |
| No.        | MP006-A-R-SD-2.1 |     |       |
| ANGLE      |                  | QTY | 3,000 |
| UNIT       | mm               |     |       |
|            |                  |     |       |
| ABLIC Inc. |                  |     |       |



No. PG006-A-P-SD-2.1

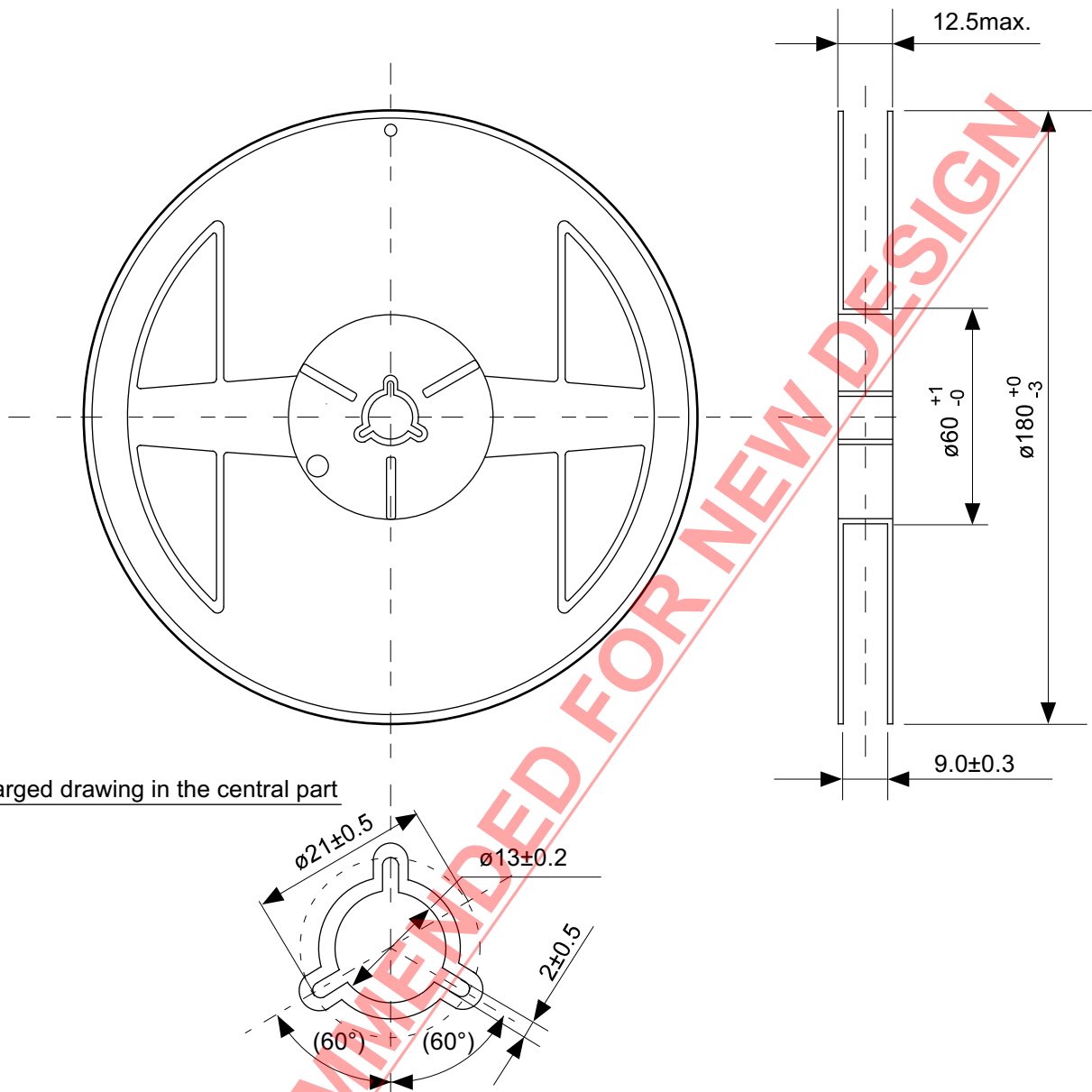
|            |                                                                                       |
|------------|---------------------------------------------------------------------------------------|
| TITLE      | SNT-6A-A-PKG Dimensions                                                               |
| No.        | PG006-A-P-SD-2.1                                                                      |
| ANGLE      |  |
| UNIT       | mm                                                                                    |
|            |                                                                                       |
| ABLIC Inc. |                                                                                       |



Feed direction

No. PG006-A-C-SD-2.0

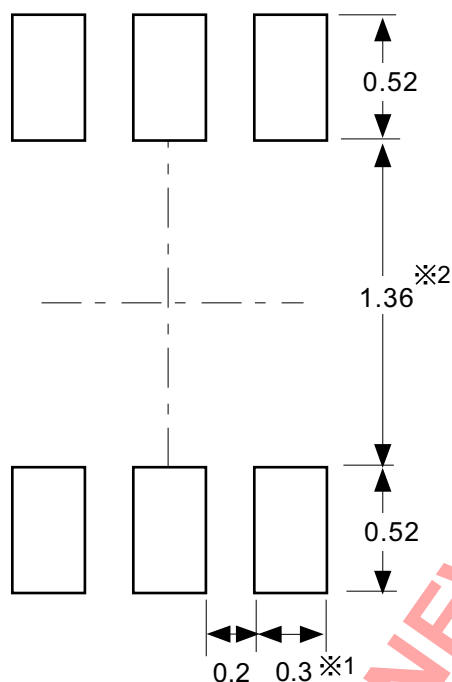
|            |                       |
|------------|-----------------------|
| TITLE      | SNT-6A-A-Carrier Tape |
| No.        | PG006-A-C-SD-2.0      |
| ANGLE      |                       |
| UNIT       | mm                    |
|            |                       |
| ABLIC Inc. |                       |



Enlarged drawing in the central part

No. PG006-A-R-SD-1.0

|            |                  |      |       |
|------------|------------------|------|-------|
| TITLE      | SNT-6A-A-Reel    |      |       |
| No.        | PG006-A-R-SD-1.0 |      |       |
| ANGLE      |                  | QTY. | 5,000 |
| UNIT       | mm               |      |       |
|            |                  |      |       |
| ABLIC Inc. |                  |      |       |



※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.).

※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意
1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
  2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
  3. マスク開口サイズと開口位置はランドパターンと合わせてください。
  4. 詳細は "SNTパッケージ活用の手引き" を参照してください。

※1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).

※2. Do not widen the land pattern to the center of the package ( 1.30 mm ~ 1.40 mm ).

- Caution**
1. Do not do silkscreen printing and solder printing under the mold resin of the package.
  2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
  3. Match the mask aperture size and aperture position with the land pattern.
  4. Refer to "SNT Package User's Guide" for details.

※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.).

※2. 请勿向封装中间扩展焊盘模式 (1.30 mm ~ 1.40 mm)。

- 注意
1. 请勿在树脂型封装的下面印刷丝网、焊锡。
  2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
  3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
  4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PG006-A-L-SD-4.1

|            |                                  |
|------------|----------------------------------|
| TITLE      | SNT-6A-A<br>-Land Recommendation |
| No.        | PG006-A-L-SD-4.1                 |
| ANGLE      |                                  |
| UNIT       | mm                               |
|            |                                  |
| ABLIC Inc. |                                  |

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2.0-2018.01

# Mouser Electronics

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## ABLIC:

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